

# **KA1H0165R**

# **SAMSUNG POWER SWITCH**

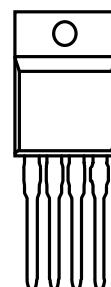
## **FEATURES**

- Precision fixed operating frequency (100KHz)
- Pulse by pulse over current limiting
- Over Current Protection
- Over Voltage Protection(min. 23V)
- Internal thermal shutdown function
- Under voltage lockout
- Internal high voltage sense FET
- Auto restart

## **PRODUCT SUMMARY**

Part Number	BVdss	Rds(on)	ID
KA1H0165R	650V	10Ω	1A

**TO-220F**



## **BLOCK DIAGRAM**

## ABSOLUTE MAXIMUM RATINGS

Characteristic	Symbol	Value	Unit
Drain - Source(GND) Voltage (1)	V <sub>DSS</sub>	650	V
Drain - Gate Voltage ( $R_{GS} = 1M\Omega$ )	V <sub>DGR</sub>	650	V
Gate - Source(GND) Voltage	V <sub>GS</sub>	$\pm 30$	V
Drain Current Pulsed (2)	I <sub>DM</sub>	4.0	A <sub>DC</sub>
Single Pulsed Avalanche Energy (3)	E <sub>AS</sub>	95	mJ
Avalanche Current	I <sub>AS</sub>	1.0	A
Continuous Drain Current ( $T_c = 25^\circ C$ )	I <sub>D</sub>	1.0	A <sub>DC</sub>
Continuous Drain Current ( $T_c = 100^\circ C$ )	I <sub>D</sub>	0.7	A <sub>DC</sub>
Supply Voltage	V <sub>C</sub>	30	V
Analog Input Voltage Range	V <sub>FB</sub>	-0.3 ~ V <sub>SD</sub>	V
Total Power Dissipation	P <sub>D</sub> ( wt H/S)	40	W
	Derating	0.32	W/°C
Operating Temperature	T <sub>OPR</sub>	- 25 ~ + 85	°C
Storage Temperature	T <sub>STG</sub>	- 55 ~ + 150	°C

Notes: (1)  $T_j = 25^\circ C$  to  $150^\circ C$

(2) Repetitive rating : Pulse width limited by maximum junction temperature

(3)  $L = 80mH$ ,  $V_{DD} = 50V$ ,  $R_G = 27\Omega$ , starting  $T_j = 25^\circ C$

## ELECTRICAL CHARACTERISTICS ( SFET part )

(  $T_a = 25^\circ C$  unless otherwise specified )

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	650	-	-	V	V <sub>GS</sub> =0V, I <sub>D</sub> =50uA
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	-	-	50	uA	V <sub>D</sub> =Max, Rating, V <sub>GS</sub> =0V
		-	-	200	uA	V <sub>D</sub> =0.8Max, Rating, V <sub>GS</sub> =0V TC=125 °C
R <sub>D(on)</sub>	Static Drain-Source On Resistance(4)	-	8	10	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 0.5A

**ELECTRICAL CHARACTERISTICS ( SFET part continued)**

( Ta = 25 °C unless otherwise specified )

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
g <sub>fs</sub>	Forward Transconductance(4)	0.5	-	-	mho	V <sub>DS</sub> =50V, I <sub>D</sub> =0.5A
C <sub>iss</sub>	Input Capacitance	-	250	-	pF	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 25V, f = 1MHz
C <sub>oss</sub>	Output Capacitance	-	25	-		
C <sub>rss</sub>	Reverse Transfer Capacitance	-	10	-		
t <sub>d(on)</sub>	Turn On Delay Time	-	12	-	nS	V <sub>DD</sub> = 0.5BV <sub>DSS</sub> , I <sub>D</sub> = 1.0A (MOSFET switching time are essentiaiy independent of operating temperature )
t <sub>r</sub>	Rise Time	-	4	-		
t <sub>d(off)</sub>	Turn Off Delay Time	-	30	-		
t <sub>f</sub>	Fall Time	-	10	-		
Q <sub>g</sub>	Total Gate Charge ( Gate-Source + Gate-Drain )	-	-	21	nC	V <sub>GS</sub> = 10V, I <sub>D</sub> = 1.0A V <sub>DS</sub> = 0.5BV <sub>DSS</sub> (MOSFET switching time are essentiaiy independent of operating temperature )
Q <sub>gs</sub>	Gate-Source Charge	-	3	-		
Q <sub>gd</sub>	Gate-Drain(Miller) Charge	-	9	-		

Notes: (1) T<sub>J</sub> = 25 °C to 150 °C

(2) Repetitive rating : Pulse width limited by maximum junction temperature

(3) L = 80mH, V<sub>DD</sub> =50V, R<sub>G</sub> = 27Ω, starting T<sub>j</sub> = 25 °C

(4) Pulse Test : Pulse width ≤ 300uS, Duty Cycle ≤ 2 %

**ELECTRICAL CHARACTERISTICS ( Control part )**

( Ta = 25 °C unless otherwise specified )

Symbol	Characteristics	Min	Typ	Max	Unit	Test Conditions
<b>REFERENCE SECTION</b>						
Vref	Output Voltage (Note 1)	4.80	5.00	5.20	V	Ta = 25 °C
Vref/ ΔT	Temperature Stability (Note 1&2)	-	0.3	0.6	mV/°C	-25 °C ≤ Ta ≤ +85 °C
<b>OSCILLATOR SECTION</b>						
Fosc	Initial Accuracy	90	100	110	KHz	Ta = 25 °C
ΔF / ΔT	Frequency Change with Temperature (Note 2)	-	±5	±10	%	-25 °C ≤ Ta ≤ +85 °C
<b>PWM SECTION</b>						
D <sub>MAX</sub>	Maximum Duty Cycle	64	67	70	%	
<b>FEEDBACK SECTION</b>						
I <sub>FB</sub>	Feedback Source Current	0.7	0.9	1.1	mA	Ta = 25 °C, 0 V ≤ V <sub>fb</sub> ≤ 3V
I <sub>delay</sub>	Shutdown Delay Current	4.0	5.0	6.0	uA	Ta = 25 °C, 5 V ≤ V <sub>fb</sub> ≤ V <sub>SD</sub>
<b>OVER CURRENT PROTECTION SECTION</b>						
I <sub>L(MAX)</sub>	Over Current Protection	0.53	0.6	0.67	A	Max. Inductor Current
<b>UVLO SECTION</b>						
V <sub>th(H)</sub>	Start Threshold Voltage	14	15	16	V	
V <sub>th(L)</sub>	Minimum Operating Voltage	9	10	11	V	After turn on

**ELECTRICAL CHARACTERISTICS ( Continued)**

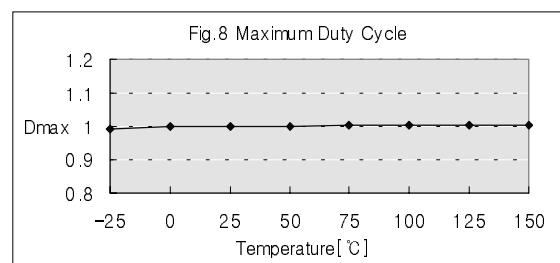
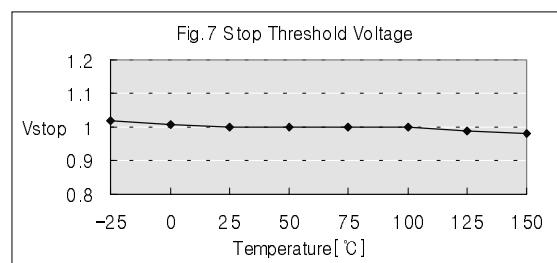
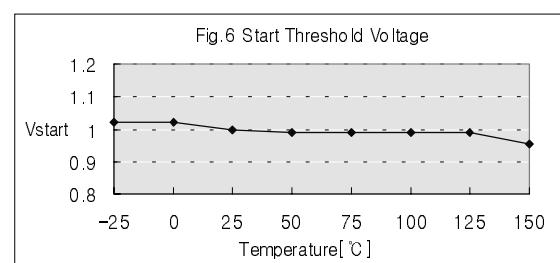
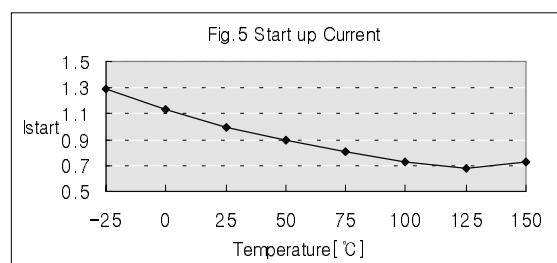
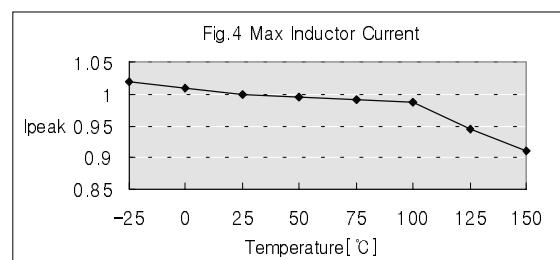
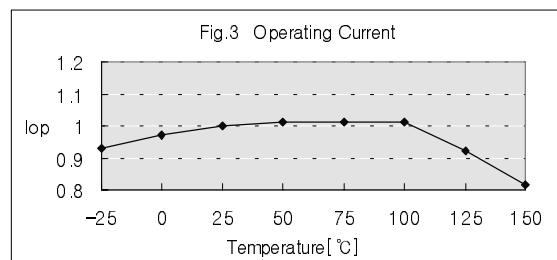
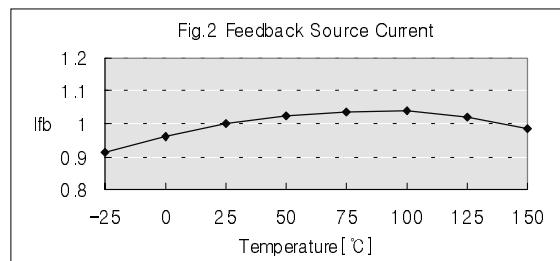
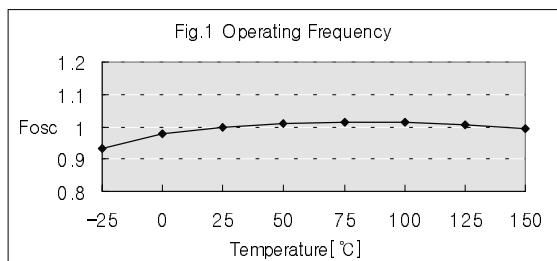
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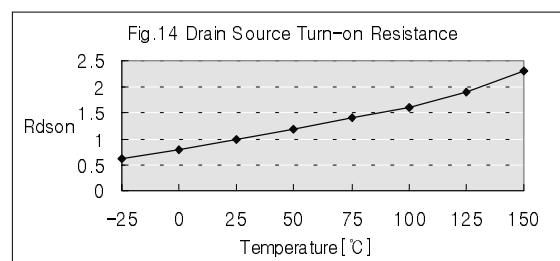
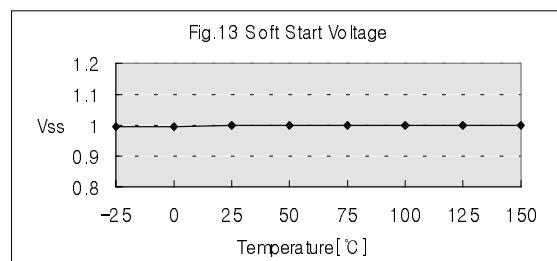
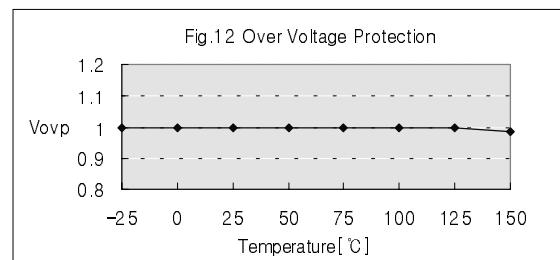
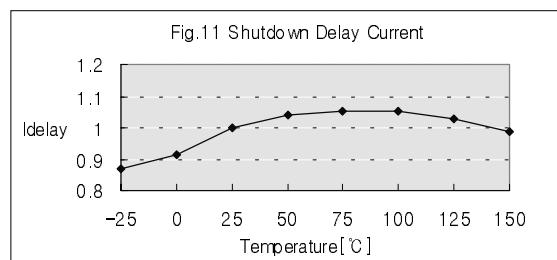
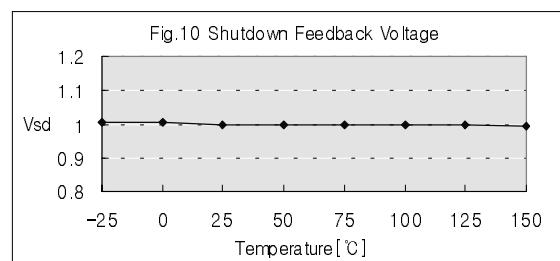
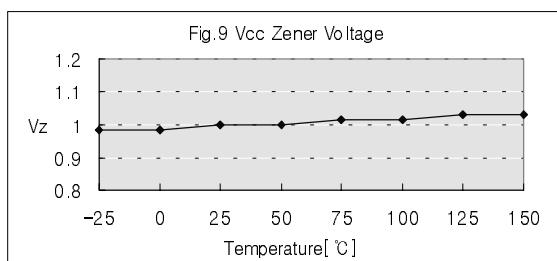
Symbol	Characteristics	Min	Typ	Max	Unit	Test Conditions
<b>TOTAL STANDBY CURRENT SECTION</b>						
I <sub>ST</sub>	Start up Current	0.1	0.3	0.45	mA	V <sub>CC</sub> = 14V
I <sub>OPR</sub>	Operating Supply Current ( control part only )	6	12	18	mA	T <sub>a</sub> = 25 °C
V <sub>Z</sub>	V <sub>CC</sub> Zener Voltage	30	32.5	35	V	I <sub>CC</sub> = 20mA
<b>SHUTDOWN SECTION</b>						
V <sub>SD</sub>	Shutdown Feedback Voltage	6.9	7.5	8.1	V	
T <sub>SD</sub>	Thermal Shutdown Temperature(T <sub>j</sub> )	140	160	-	°C	(Note 1)
V <sub>OVP</sub>	Over Voltage Protection Voltage	23	25	28	V	

Notes: (1) These parameters, although guaranteed, are not 100% tested in production

(2) These parameters, although guaranteed, are tested in EDS(wafer test) process

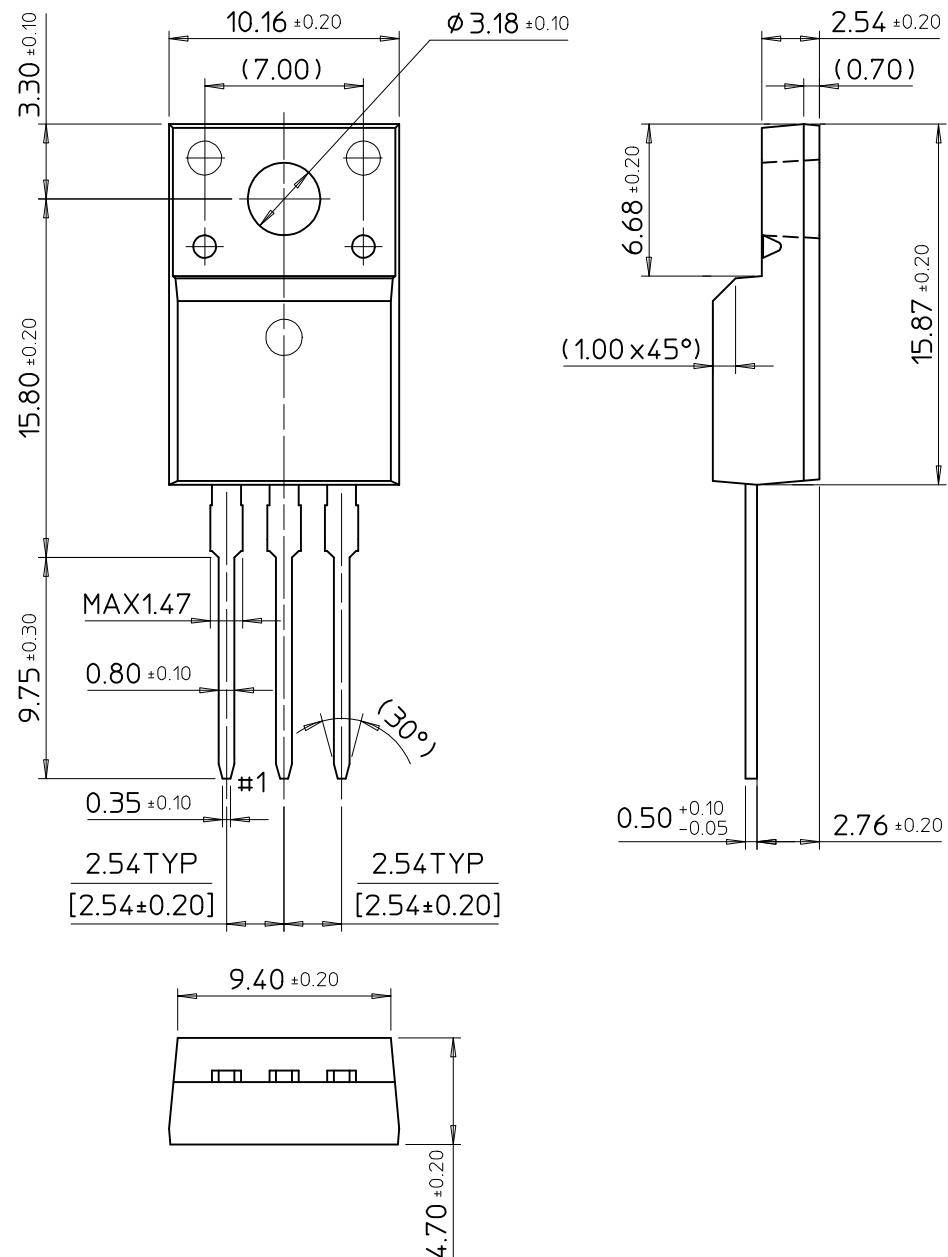
## TYPICAL PERFORMANCE CHARACTERISTICS



**TYPICAL PERFORMANCE CHARACTERISTICS (Continued)**

# TO-220F

Dimensions in Millimeters



SAMSUNG ELECTRONICS CO.,LTD.